HAY www.vishay.com

Vishay General Semiconductor

Surface Mount Ultrafast Plastic Rectifier



DO-214AA (SMB)

PRIMARY CHARACTERISTICS				
I _{F(AV)}	2.0 A			
V _{RRM}	600 V			
I _{FSM}	90 A			
t _{rr}	30 ns			
V _F at I _F	1.0 V			
T _J max.	150 °C			
Package	DO-214AA (SMB)			
Diode variations	Single die			

FEATURES

- Glass passivated pellet chip junction
- Ideal for automated placement
- Ultrafast recovery times for high efficiency
- Low forward voltage, low power losses
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification, and freewheeling application in switching mode converters and inverters for consumer, computer, and telecommunication.

MECHANICAL DATA

Case: DO-214AA (SMB) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	USB260	UNIT		
Device marking code		U60			
Maximum repetitive peak reverse voltage	V _{RRM}	600	V		
Maximum RMS voltage	V _{RMS}	420	V		
Maximum DC blocking voltage	V _{DC}	600	V		
Maximum average forward rectified current (fig. 1)	I _{F(AV)}	2.0	A		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	90	А		
Non-repetitive avalanche energy at I_{AS} = 2.0 A, L = 10 mH, T_J = 25 $^\circ\text{C}$	E _{AS}	20	mJ		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150	°C		



www.vishay.com

USB260

Vishay General Semiconductor

ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Breakdown voltage	I _R = 10 μA	T _J = 25 °C	V _{BR}	600 (minimum)		V
Instantaneous forward voltage	I _F = 1 A	T _J = 25 °C	V _F ⁽¹⁾	1.25	-	V
	I _F = 2.0 A	T _J = 25 °C		1.5	1.6	
		T _J = 125 °C		1.0	1.1	
Maximum reverse current	V _B = 600 V	T _J = 25 °C	I _R (2)	-	5.0	μA
	$v_{\rm R} = 000 v$	T _J = 125 °C		30	100	
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	30		ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	45		pF

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	USB260	UNIT		
Typical thermal resistance	R _{0JA} ⁽¹⁾	45	°C/W		
rypical mermanesistance	$R_{\theta JL}$ ⁽¹⁾	10			

Note

⁽¹⁾ Units mounted on PCB with 2.0" x 2.0" copper pad areas

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
USB260-M3/52T	0.096	52T	750	7" diameter plastic tape and reel	
USB260-M3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel	
USB260HM3/52T	0.096	52T	750	7" diameter plastic tape and reel	
USB260HM3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel	



Vishay General Semiconductor

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

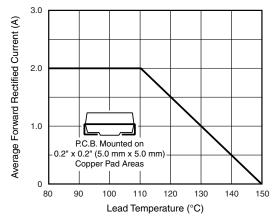


Fig. 1 - Maximum Forward Current Derating Curve

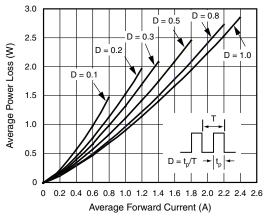


Fig. 2 - Forward Power Loss Characteristics

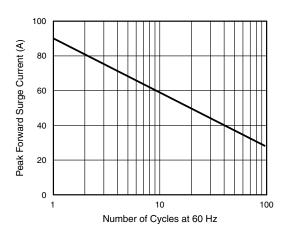


Fig. 3 - Maximum Non-Repetitive Peak Forward Surge Current

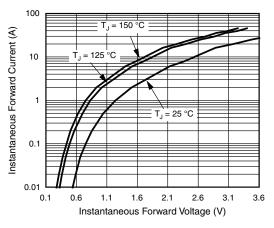


Fig. 4 - Typical Instantaneous Forward Characteristics

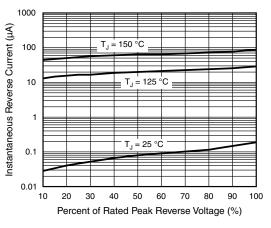


Fig. 5 - Typical Reverse Leakage Characteristics

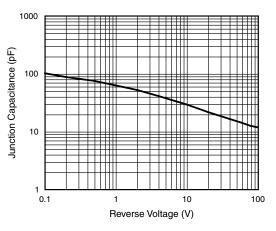


Fig. 6 - Typical Junction Capacitance

Revision: 20-Feb-15

3

Document Number: 89483

For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFI Downloaded From <u>Oneyac.com</u> <u>W.vishay.com/doc?91000</u>



Vishay General Semiconductor

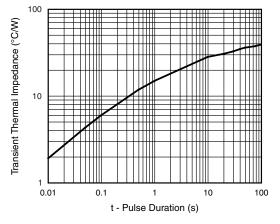
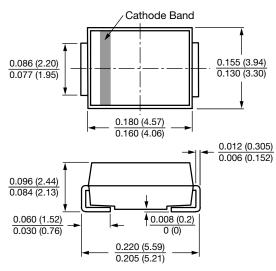


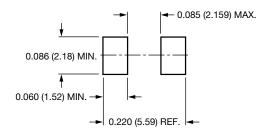
Fig. 7 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



DO-214AA (SMB)

Mounting Pad Layout





Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.



单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)

>>点击查看相关商品